

One-cell Li-ion/Li-polymer battery protection IC

MJ3401 series

Outline

MJ3401 series are protection IC with integrated MOS-FET for protection of the rechargeable Lithium-ion or Lithium-polymer battery. The overcharge, overdischarge and discharging and charging overcurrent protection of the rechargeable one-cell Lithium-ion or Lithium-polymer battery can be detected. It's possible by OTP technology to detect unusual state of a Li-ion battery with very high accuracy.

| Features | stion /rolongo valtago | | otherwise specified,Ta=25℃ | | |
|--|---|---|--------------------------------|--|--|
| Range and accuracy of determined of the second secon | - | 4.1V to 4.60V, 5mV steps | Accuracy±10mV | | |
| Overcharge release hysteresis voltage | | Selection from 0V, 0.1V, 0.2V | Accuracy=10111 | | |
| | | 2.00V to 3.00V, 100mV step | Accuracy±35mV | | |
| | | Selection from 0V, 0.2V, 0.3V, 0.4V | Accuracy±55mv | | |
| - | Overdischarge release hysteresis voltage Discharging overcurrent detection current | | | | |
| | | | | | |
| Charging overcurrent detection current Short detection voltage | | 4.0A to 8.0A, 0.1A step *1 180mV to 360mV, 10mV step | Accuracy±15mV | | |
| *1 Please inquire to us about which is varies dependin | | racy of Overcurrent detection current, e. | | | |
| 2) Range of detection delay tir | ne | | | | |
| • Overcharge detection de | lay time | Selection from 1.024s, 4.60s | | | |
| Overdischarge detection | delay time | Selection from 20ms, 96ms, 144ms | | | |
| Discharging overcurrent detection delay time Charging overcurrent detection delay time | | Selection from 6ms, 8ms, 12ms, 16ms | , 20ms, 32ms, 128ms, 256m | | |
| | | Selection from 8ms, 16ms, 32ms | Selection from 8ms, 16ms, 32ms | | |
| Short detection delay time | | Selection from 500us, 820us | | | |
| 3) 0V battery charge function | | Selection from "Prohibition" or "Permission" | | | |
| 4) Low current consumption | | | | | |
| Normal mode | Typ. 4.5uA, Ma | ax. 7.0uA | | | |
| Stand-by mode | Max. 0.1uA (Ir | case Overdischarge latch function "Enable") | | | |
| | Max. 0.3uA (Ir | n case Overdischarge latch function "Dis | sable") | | |
| 5) MOS-FET | | | | | |
| Source to Source on state resistance | | Typ. 11mΩ (@VDD=3.6V) | | | |
| 6) Package type | | | | | |
| ・PLP-6G | | 4.10 × 2.10 × 0.50 [mm] | | | |

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https://mtm-sec.mitsumi.co.jp/web/ic/

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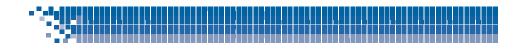
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Pin explanations

| PLP-6G | Pin No. | Symbol | Function |
|---|---------|--------|--|
| | 1 | S1 | Source terminal of discharge MOS-FET. Connect to the negative terminal of the battery. |
| | 2 | VSS | Negative power supply voltage input terminal. Connect to the negative terminal of the battery. |
| 1 6 | 3 | VPP | Test terminal. VPP terminal must be connected to VSS terminal . |
| 2 CIII D CIII 5 3 CIII CIII 4 | 4 | VDD | Positive power supply voltage input terminal. Connect to the positive terminal of the battery through R1. |
| · · · · · · · · · · · · · · · · · · · | 5 | V- | Charger negative voltage input terminal. Connect to the S2 terminal through R2. |
| | 6 | S2 | Source terminal of charge MOS-FET. Connect to a negative power supply terminal of charger. |
| | - | D | Drain terminal of discharge and charge MOS-FET. Drain terminal must be open electrically. |



Absolute Maximum Ratings

| Parameter | Symbol | Min | Max | Unit |
|----------------------|--------|--------|---------|------|
| Supply voltage | VDD | -0.3 | 10 | V |
| V- terminal voltage | V- | VDD-24 | VDD+0.3 | V |
| Drain-source voltage | VDSS | - | 24 | V |
| Source current | IS | - | 12 | А |
| Storage temperature | Tstg | -55 | 125 | °C |

Recommended Operating Conditions

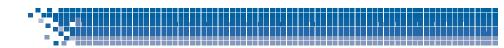
| Parameter | Symbol | Min | Max | Unit |
|-------------------------------|--------|-----|-----|------|
| Operating ambient temperature | Topr | -40 | 85 | °C |
| Operating voltage | Vop | 1.5 | 5.5 | V |

Electrical characteristics

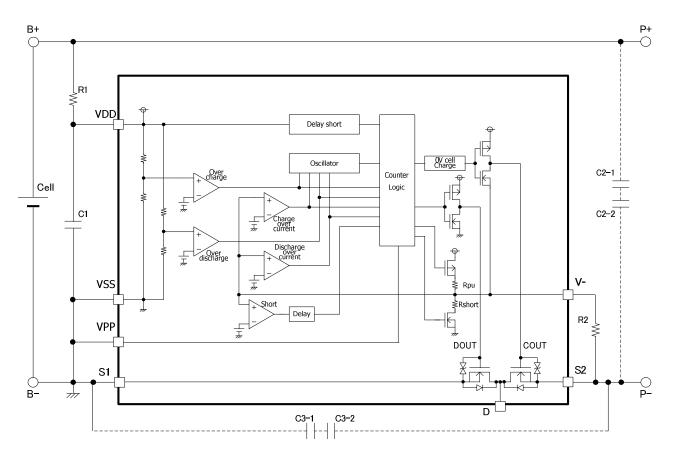
| Parameter | Symbol | Note | Min | Тур | Max | Unit |
|--|-----------|-------------------------|--------------------|---------|-----------|------|
| | 0, | Current consumption | | • 78 | T lux | • |
| Current consumption | Idd | VDD=4.0V, V-=0V | - | 4.5 | 7.0 | uA |
| | 100 | Vdet2=Vrel2 | - | - | 0.1 | uA |
| Current consumption at stand-by | Istb | Vdet2≠Vrel2 | _ | 0.15 | 0.30 | uA |
| | | Detection/Release volta | age | | | |
| Overcharge detection voltage | Vdet1 | | Typ-0.010 | Vdet1 | Typ+0.010 | V |
| | | Vdet1=Vrel1 | Typ-0.030 | | Typ+0.010 | V |
| Overcharge release voltage | Vrel1 | Vdet1≠Vrel1 | Typ-0.030 | Vrel1 | Typ+0.030 | V |
| Overdischarge detection voltage | Vdet2 | | Typ-0.035 | Vdet2 | Typ+0.035 | V |
| | 1/ 10 | Vdet2=Vrel2 | Typ-0.035 | | Typ+0.045 | V |
| Overdischarge release voltage | Vrel2 | Vdet2≠Vrel2 | Typ-0.090 | Vrel2 | Typ+0.090 | V |
| Discharge Overcurrent detection voltage | Vdet3 | | Idch3 | V | | |
| Charge Overcurrent detection voltage | Vdet4 | | -Ichg36*Rsson36 %2 | | | V |
| Short detection voltage | Vshort | | Typ-0.015 | Vshort | Typ+0.015 | V |
| 0V battery charge inhibition battery voltage | Vst | | 0.60 | 0.90 | 1.20 | V |
| ov battery charge inhibition battery voltage | | | 1.10 | 1.25 | 1.40 | V |
| 0V battery charge permission charger voltage | Vst | | - | - | 1.60 | V |
| | | Detection delay time | | | | |
| Overcharge detection delay time | tVdet1 | | Typ*0.8 | tVdet1 | Typ*1.2 | S |
| Overdischarge detection delay time | tVdet2 | | Typ*0.8 | tVdet2 | Typ*1.2 | ms |
| Discharging overcurrent detection delay time | tVdet3 | | Typ*0.8 | tVdet3 | Typ*1.2 | ms |
| Charging overcurrent detection delay time | tVdet4 | | Typ*0.8 | tVdet4 | Typ*1.2 | ms |
| Short detection delay time | tVshort | | ※ 2 | tVshort | ※2 | us |
| | | MOS-FET | | | | |
| Drain current of cut off | IDSS | VDS=24V | - | - | 1.0 | uA |
| Source to source on state resistance 45 | RSS(on)45 | VDD=4.5V , Is=1.0A | 7.0 | 11.0 | 15.0 | mΩ |
| Source to source on state resistance 35 | RSS(on)35 | VDD=3.5V , Is=1.0A | 7.0 | 11.0 | 15.0 | mΩ |
| Source to source on state resistance 25 | RSS(on)25 | VDD=2.5V , Is=1.0A | 7.7 | 12.7 | 17.7 | mΩ |
| Body diode forward voltage | VSD | Is=1A | 0.45 | 0.60 | 0.80 | V |

※2 Please inquire to us about details of the accuracy of Overcurrent detection current and Short detction delay time, which is varies depending on the setting value.





Block diagram / Typical application circuit



| Symbol | Part | Min. | Тур. | Max. | Unit |
|--------|-----------|------|------|------|------|
| R1 | Resistor | - | 330 | - | Ω |
| C1 | Capacitor | 0.01 | 0.1 | 1.0 | uF |
| R2 | Resistor | - | 1.0 | 10.0 | kΩ |
| C2/C3 | Capacitor | 0.01 | 0.1 | 1.0 | uF |

%Application hints

The resistors that are inserted into each pin are to protect the IC. They help to remove ESD and latch-up damages. The capacitors help to reduce the effects of transient variations in voltage and electromagnetic waves, and to improve ESD tolerance of the IC.Please use either C2 or C3, or both of them by request of your application.

These values in the above figure are for example. Please choose appropriate values.